

() Preliminary Specifications(V) Final Specifications

Module	13.3" WXGA Color TFT-LCD
Model Name	B133EW04 V1
Note (🗭	LED Backlight without driving circuit design

Customer	Date
Checked & Approved by	Date
Note: This Specification is notice.	subject to change without

Approved by	Date			
<u>Howard Lee</u>	<u>11/19/2008</u>			
Prepared by	Date			
<u>Johnson Kuo</u>	<u>11/19/2008</u>			
NBBU Marketing Division / AU Optronics corporation				



Contents

1.	. Handling Precautions	4
2.	. General Description	5
	2.1 General Specification	
	2.2 Optical Characteristics	6
3.	. Functional Block Diagram	8
4.	. Absolute Maximum Ratings	9
	4.1 Absolute Ratings of TFT LCD Module	9
	4.2 Absolute Ratings of Backlight Unit	9
	4.3 Absolute Ratings of Environment	9
5.	. Electrical characteristics	10
	5.1 TFT LCD Module	10
	5.2 Backlight Unit	12
6.	. Signal Characteristic	
	6.1 Pixel Format Image	14
	6.2 The input data format	15
	6.3 Signal Description/Pin Assignment	
	6.4 Interface Timing	17
7.	. Connector Description	20
	7.1 TFT LCD Module	20
8.	. Dynamic Test	21
	8.1 Vibration Test	21
	8.2 Shock Test Spec:	21
9.	. Reliability	
10	0. Mechanical Characteristics	2 3
	10.1 LCM Outline Dimension	23
11	1. Shipping and Package	27
	11.1 Shipping Label Format	27
	11.2 Carton package	
	11.3 Shipping package of palletizing sequence	29
12	2. Appendix: EDID description	30



Record of Revision

Ver	sion and Date	Page	Old description	New Description	Remark
0.1	2008/08/29	All	First Edition for Customer		



AU OPTRONICS CORPORATION

1. Handling Precautions

- 1) Since front polarizer is easily damaged, pay attention not to scratch it.
- 2) Be sure to turn off power supply when inserting or disconnecting from input connector.
- 3) Wipe off water drop immediately. Long contact with water may cause discoloration or spots.
- 4) When the panel surface is soiled, wipe it with absorbent cotton or other soft cloth.
- 5) Since the panel is made of glass, it may break or crack if dropped or bumped on hard surface.
- 6) Since CMOS LSI is used in this module, take care of static electricity and insure human earth when handling.
- 7) Do not open nor modify the Module Assembly.
- 8) Do not press the reflector sheet at the back of the module to any directions.
- 9) In case if a Module has to be put back into the packing container slot after once it was taken out from the container, do not press the center of the LED lamp Reflector edge. Instead, press at the far ends of the LED lamp Reflector edge softly. Otherwise the TFT Module may be damaged.
- 10) At the insertion or removal of the Signal Interface Connector, be sure not to rotate nor tilt the Interface Connector of the TFT Module.
- 11) After installation of the TFT Module into an enclosure (Notebook PC Bezel, for example), do not twist nor bend the TFT Module even momentary. At designing the enclosure, it should be taken into consideration that no bending/twisting forces are applied to the TFT Module from outside. Otherwise the TFT Module may be damaged.
- 12) Small amount of materials having no flammability grade is used in the LCD module. The LCD module should be supplied by power complied with requirements of Limited Power Source (IEC60950 or UL1950), or be applied exemption.
- 13) Disconnecting power supply before handling LCD modules, it can prevent electric shock, DO NOT TOUCH the electrode parts, cables, connectors and LED circuit part of TFT module that a LED light bar build in as a light source of back light unit. It can prevent electrostic breakdown.

4 of 33



AU OPTRONICS CORPORATION

2. General Description

B133EW04 V1 is a Color Active Matrix Liquid Crystal Display composed of a TFT LCD panel, a driver circuit, and backlight system. The screen format is intended to support the WXGA (1280(H) x 800(V)) screen and 262k colors (RGB 6-bits data driver) without backlight inverter. All input signals are LVDS interface compatible.

B133EW04 V1 is designed for a display unit of notebook style personal computer and industrial machine.

2.1 General Specification

The following items are characteristics summary on the table at 25 $^{\circ}\mathrm{C}$ condition:

Items	Unit		Specifica	ntions		
Screen Diagonal	[mm]	337.8 (13.3W	<i>I</i> ")			
Active Area	[mm]	286.08 (H) X 178.8 (V)				
Pixels H x V		1280x3(RGB) x 800				
Pixel Pitch	[mm]	0.2235 x 0.2235				
Pixel Format		R.G.B. Vertical Stripe				
Display Mode		Normally White				
White Luminance	[cd/m ²]	275 typ @ 95				
Note: ILED is lamp current		248 min @ 95% duty cycle				
Luminance Uniformity	<u>%</u>	50 max. (160 points)				
Contrast Ratio		500 typ, 400r	min			
Response Time	[ms]	16 typ, 25 ma	ax			
Nominal Input Voltage	[Volt]	+3.3 typ.				
Power Consumption	[Watt]	4.3 W @ Bla	ck (typical)			
Weight	[Grams	300(typical),	310 (max.)			
Physical Size	[mm]		L	W	Т	
		Max			3.6	
		Typical Min	297.15	203.15	-	
Electrical Interface		one channel LVDS				
Surface Treatment		Glare, Hardn	ess 3H,			

AUO NBBU spec. Template 1.0 5 of 33



Support Color		262K colors (RGB 6-bit)
Temperature Range Operating Storage (Non-Operating)	[°C]	0 to +50 -25 to +65
RoHS Compliance		RoHS Compliance

2.2 Optical Characteristics The optical characteristics are measured under stable conditions at 25 $^\circ$ C (Room Temperature) :

Item	Unit	Conditions	Min.	Тур.	Max.	Note
White Luminance	[cd/m ²]	160 points average	248	275	-	1,2,3
	[degree] [degree]	Right/left	40/40	50/50		
Viewing Angle	[degree] [degree]	Up Down	15 30	25 35	-	1,2,3
Luminance Uniformity	%	160 point	50	•		1,2
CR: Contrast Ratio			400	500	ı	1,2,3
Cross talk	%	Optical			2.0	1,2,3
Response Time	[msec]	Rising + Falling	-	16	25	
		Red x	0.575	0.595	0.615	
Chromaticity of color Coordinates	%	Red y	0.325	0.345	0.365	1,2,3
(CIE 1931)		Green x	0.300	0.320	0.340	,,_,
, ,		Green y	0.535	0.555	0.575	
NTSC		Blue x	0.135	0.155	0.175	
		Blue y	0.125	0.145	0.165	
		White x	0.297	0.313	0.329	
		White y	0.313	0.329	0.345	
		CIE 1931	-	45	-	



Note 1: The testing conditions are specified in 2.3

Note 2: The definitions of optical characteristics are shown in 2.4

Note 3: Measured at center point. Equivalent performance over the entire panel required

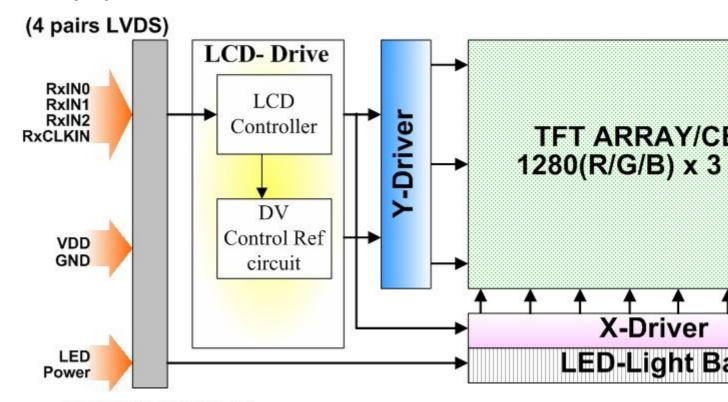
Note 4: Both center point and average of 160 points



AU OPTRONICS CORPORATION

3. Functional Block Diagram

The following diagram shows the functional block of the 13.3 inches wide Color TFT/LCD Module:



IPEX 20474-030E-12

8 of 33



AU OPTRONICS CORPORATION

4. Absolute Maximum Ratings

An absolute maximum rating of the module is as following:

4.1 Absolute Ratings of TFT LCD Module

Item	Symbol	Min	Max	Unit	Conditions
Logic/LCD Drive Voltage	Vin	-0.3	+4.0	[Volt]	Note 1,2

4.2 Absolute Ratings of Backlight Unit

Item	Symbol	Min	Max	Unit	Conditions
LED Current	ILED	-	35	[mA] rms	Note 1,2

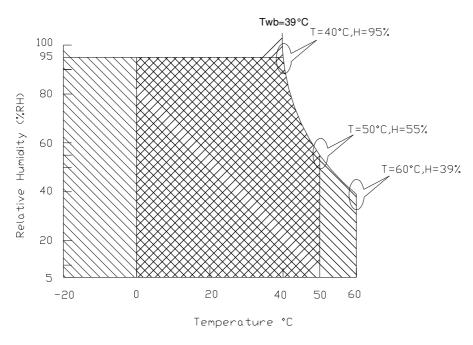
4.3 Absolute Ratings of Environment

Item	Symbol	Min	Max	Unit	Conditions
Operating Temperature	TOP	0	+50	[°C]	Note 3
Operation Humidity	HOP	5	95	[%RH]	Note 3
Storage Temperature	TST	-20	+60	[°C]	Note 3
Storage Humidity	HST	5	95	[%RH]	Note 3

Note 1: At Ta (25°C)

Note 2: Permanent damage to the device may occur if exceed maximum values

Note 3: For quality performance, please refer to AUO IIS (Incoming Inspection Standard).



Operating Range

Storage Range

+



5. Electrical characteristics

5.1 TFT LCD Module

5.1.1 Power Specification

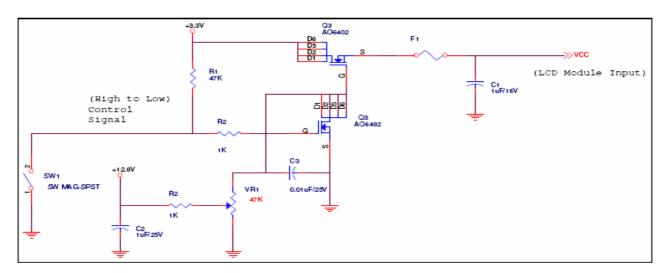
Input power specifications are as follows;

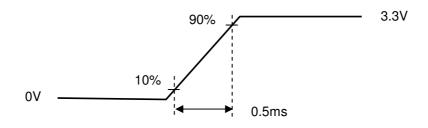
Symble	Parameter	Min	Тур	Max	Units	Note
VDD	Logic/LCD Drive	3.0	3.3	3.6	[Volt]	
PDD	VDD Power	-		0.9	[Watt]	Note 1/2
IDD	IDD Current	-	220	250	[mA]	Note 1/2
lRush	Inrush Current	-	0.7	1.5	[A]	Note 3
VDDrp	Allowable Logic/LCD Drive Ripple Voltage	-	-	100	[mV] p-p	

Note 1: Maximum Measurement Condition: Black Pattern

Note 2: Typical Measurement Condition: Mosaic Pattern

Note 3: Measure Condition





Vin rising time



5.1.2 Signal Electrical Characteristics

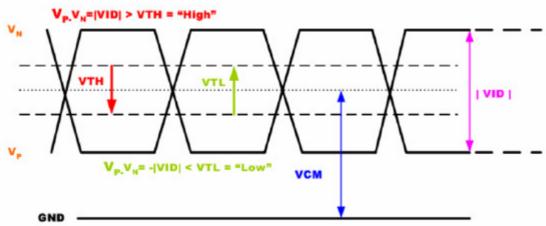
Input signals shall be low or High-impedance state when VDD is off.

Signal electrical characteristics are as follows;

Parameter	Condition	Min	Max	Unit
Vth	Differential Input High Threshold (Vcm=+1.2V)	-	+100	[mV]
VtI	Differential Input Low Threshold (Vcm=+1.2V)	-100	-	[mV]
Vcm	Differential Input Common Mode Voltage	0.8	2.0	[V]

Note: LVDS Signal Waveform







Parameter gu\\\\\\ideline for LED

LED Parameter guideline for LED driving selection (Ref. Remark 1)

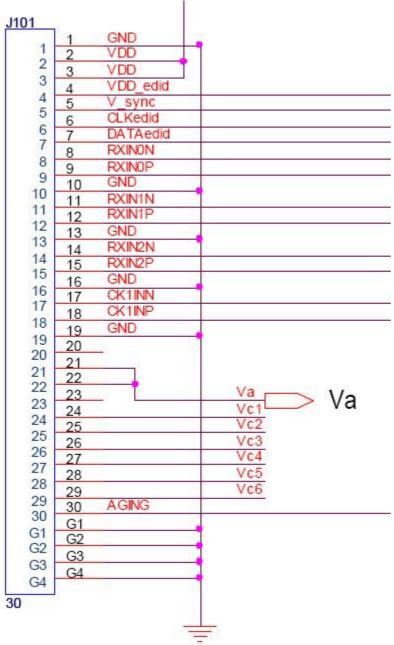
Parameter	Symbol	Min	Тур	Max	Units	Condition
LED Forward Voltage	VF	2.8	3.0	3.2	[Volt]	(Ta=25°C)
LED Forward Current	IF		20	30	[mA]	(Ta=25°C)
LED Power consumption	Pled		4		[Watt]	(Ta=25°C)
LED Fower consumption	LTED		4		[w att]	Note 1
						(Ta=25°C)
LED Life-Time\	N/A	10,000	-	-	Hour	IF=20 mA
						Note 2
Output PWM frequency	FPWM	100	200	20K	Hz	
Duty ratio @20kHZ		5		100	%	

Note 1: Calculator value for reference IF×VF =P

Note 2: The LED life-time define as the estimated time to 50% degradation of initial luminous

Note 3: Totally using 54 Led bins





13 of 33



6. Signal Characteristic

6.1 Pixel Format Image

Following figure shows the relationship of the input signals and LCD pixel format.

		0			1			1	27	8	12	279	9
1st Line	R	G	В	R	G	В		R	G	В	R	G	В
					:				:		·		
		:							:				
		:							:				
									:				
		:							:				
		· —			_		'		· —			· —	
800th Line	R	G	В	R	G	В		R	G	В	R	G	В



6.2 The input data format

RxCLKIN		
RxIN0	G0 R5 R4 R3 R2	R1 R0
RxIN1	B1 B0 G5 G4 G3	G2 G1
RxIN2	DE VS HS B5 B4	B3 B2

Cianal Name	Dagarintian	
Signal Name	Description	
R5	Red Data 5 (MSB)	Red-pixel Data
R4	Red Data 4	Each red pixel's brightness data consists of
R3	Red Data 3	these 6 bits pixel data.
R2	Red Data 2	
R1	Red Data 1	
R0	Red Data 0 (LSB)	
	Red-pixel Data	
G5	Green Data 5 (MSB)	Green-pixel Data
G4	Green Data 4	Each green pixel's brightness data consists of
G3	Green Data 3	these 6 bits pixel data.
G2	Green Data 2	
G1	Green Data 1	
G0	Green Data 0 (LSB)	
	, ,	
	Green-pixel Data	
B5	Blue Data 5 (MSB)	Blue-pixel Data
B4	Blue Data 4	Each blue pixel's brightness data consists of
B3	Blue Data 3	these 6 bits pixel data.
B2	Blue Data 2	
B1	Blue Data 1	
B0	Blue Data 0 (LSB)	
	Blue-pixel Data	
RxCLKIN	Data Clock	The typical frequency is 68.9 MHZ The signal
		is used to strobe the pixel data and DE signals.
		All pixel data shall be valid at the falling edge
		when the DE signal is high.
DE	Display Timing	This signal is strobed at the falling edge of
		RxCLKIN. When the signal is high, the pixel
		data shall be valid to be displayed.
VS	Vertical Sync	The signal is synchronized to RxCLKIN.
HS	Horizontal Sync	The signal is synchronized to RxCLKIN.

Note: Output signals from any system shall be low or High-impedance state when VDD is off.



6.3 Signal Description/Pin Assignment

LVDS is a differential signal technology for LCD interface and high speed data transfer device.

Pin	Signal	Description
1	GND	Ground
2	Vcc	Power Supply (+3.3V)
3	Vanalog	Power Supply (+3.3V)
4	VEDID	DDC Power +3.3V
5	Vsync	Vsync
6	Clkedid	DDC Clock
7	DATAEDID	DDC Data
8	Rin0-	Differential Data Input
9	Rin0+	Differential Data Input
10	GND	Ground
11	Rin1-	Differential Data Input
12	Rin1+	Differential Data Input
13	GND	Ground
14	Rin2-	Differential Data Input
15	Rin2+	Differential Data Input
16	GND	Ground
17	Clkin-	Differential Clock Input
18	Clkin+	Differential Clock Input
19	GND	Ground
20	NC	NC
21	Vdc	LED Anode (~31V)
22	Vdc	LED Anode (~31V)
23	NC	NC
24	Vdc1	LED Cathode (Ground)
25	Vdc2	LED Cathode (Ground)
26	Vdc3	LED Cathode (Ground)
27	Vdc4	LED Cathode (Ground)
28	Vdc5	LED Cathode (Ground)
29	Vdc6	LED Cathode (Ground)
30	AGING	AGING



AU OPTRONICS CORPORATION

6.4 Interface Timing

6.4.1 Timing Characteristics

Basically, interface timings should match the 1280x800 /60Hz manufacturing guide line timing.

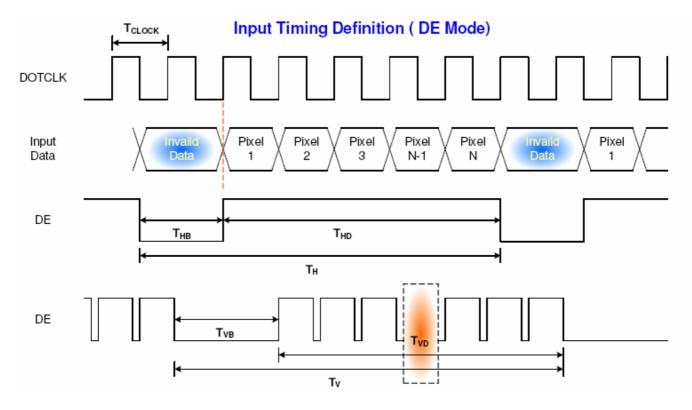
Signal	Parameter	Symbol	Min	Тур	Max	Unit	Note
D_{CLK}	Clock Period	T_{C}		13.79		ns	1
	Clock Frequency	f_C		72.50		MHz	1/T _C
	Duty Ratio (% High)	K _{dr}	40	50	60	%	T_{Ch}/T_{C}
	Rise Time	T_{RCLK}	-	4.42	-	ns	
	Fall Time	T _{F CLK}	-	4.42	-	ns	
DE	DE Setup Time	T_{se}	4	-	-	ns	
(Data Enable	Data Setup Time	T_{sd}	4	-	-	ns	
Only)	Data Hold Time	T_{hd}	2	-	-	ns	
(DTMG)	Horizontal Period	T_{H}		1440		$T_{\rm C}$	2
Data	Horizontal Blank Period	T_{ha}		160		$T_{\rm C}$	
	Vertical Period	T_{V}		823		$T_{\mathtt{H}}$	f _V =59.94 Hz, 3
	Vertical Blank Period	T_{wvb}		23		T_{H}	
H_{sync}	H _{sync} Back Porch	H_{bp}		80		$T_{\rm C}$	
	H _{sync} Pulse Width	T_{WH}		32		$T_{\mathbf{C}}$	
	H _{sync} Front Porch	H_{fp}		48		$T_{\mathbf{C}}$	
	Horizontal Active Period	T_{HD}	1280	1280	1280	$T_{\rm C}$	Display Period
$V_{\rm sync}$	V _{sync} Back Porch	V_{bp}		14		T_{H}	
	V _{sync} Pulse Width	T_{WV}		6		$T_{\mathtt{H}}$	
	V _{sync} Front Porch	V_{fp}		3		$T_{\mathtt{H}}$	
	Vertical Active Period	T_{VD}	800	800	800	$T_{\mathtt{H}}$	Display Period

Note: (1) When the WXGA+ controller sets DE Mode, and H_{sync} and V_{sync} are required. The duration of DE (DTMG) signal must be longer than 1 clock period (T_C) at every horizontal sync period;

- (2) Horizontal Period = One Line Scanning Time;
- (3) The vertical period T_V is related to the frame frequency f_V, i.e., 60 Hz.



6.4.2 Timing diagram

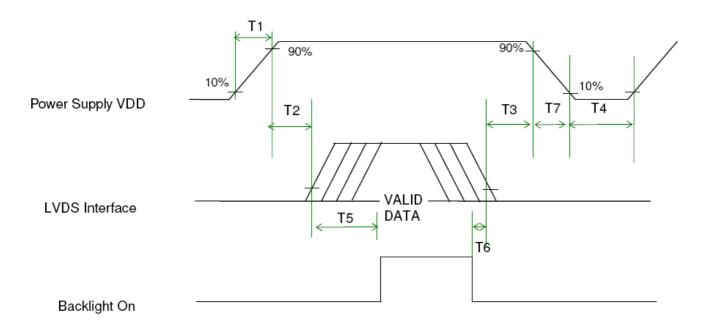




AU OPTRONICS CORPORATION

6.5 Power ON/OFF Sequence

VDD power and lamp on/off sequence is as follows. Interface signals are also shown in the chart. Signals from any system shall be Hi-Z state or low level when VDD is off.



Power Sequence Timing

Parameter	eter Min. Typ. M		Max.	Units
T1	0.5	-	10	(ms)
T2	0	-	50	(ms)
ТЗ	0	-	50	(ms)
T4	400	-	-	(ms)
T5	200	-	-	(ms)
T6	200	-	-	(ms)
T 7	0	-	10	(ms)



7. Connector Description

Physical interface is described as for the connector on module.

These connectors are capable of accommodating the following signals and will be following components.

7.1 TFT LCD Module

Connector Name / Designation	For Signal Connector		
Manufacturer	I-PEX		
Type / Part Number	I-PEX 20474-030E-12		
Mating Housing/Part Number	I-PEX 20472-030T-10		



8. Dynamic Test

8.1 Vibration Test

Test Spec:

Test method: Non-Operation

Acceleration: 3.0 G

Frequency: 5 - 150Hz Random

30 Minutes each Axis (X, Y, Z) Sweep:

8.2 Shock Test Spec:

Test Spec:

Test method: Non-Operation

Acceleration: 200 G, Half sine wave

Active time: 2 ms

Pulse: X,Y,Z .one time for each side



9. Reliability

Items	Required Condition	Note
Temperature Humidity Bias	Ta= 50℃, 90%RH, 240h	
High Temperature Operation	Ta= 50℃, RH, 300h	
Low Temperature Operation	Ta= 0℃, RH, 300h	
High Temperature Storage	Ta= 65℃, RH, 500h	
Low Temperature Storage	Ta= -25℃, RH, 500h	
Thermal Shock Test	Ta=-20℃ to 60℃, Duration at 30 min, 100 cycles	
ESD	Contact : ±8 KV	Note 1
LOD	Air: ±15 KV	

Note1: According to EN 61000-4-2, ESD class B: Some performance degradation allowed. No data lost

. Self-recoverable. No hardware failures.

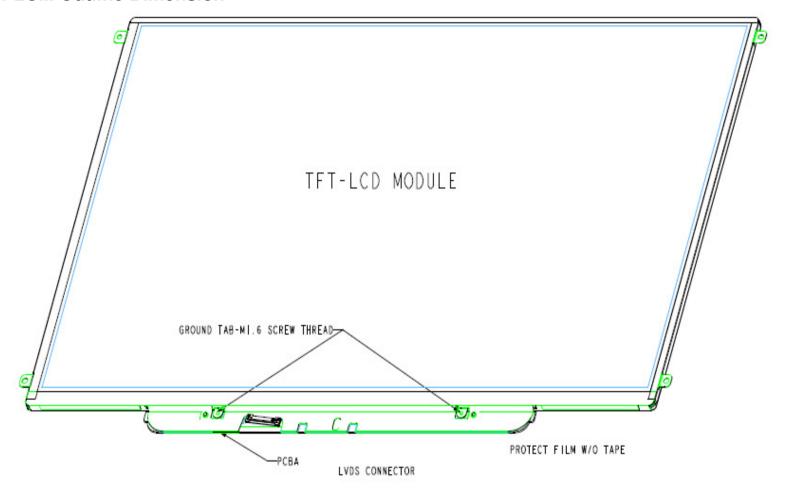
Remark: MTBF (Excluding the LED): 30,000 hours with a confidence level 90%



AU OPTRONICS CORPORATION

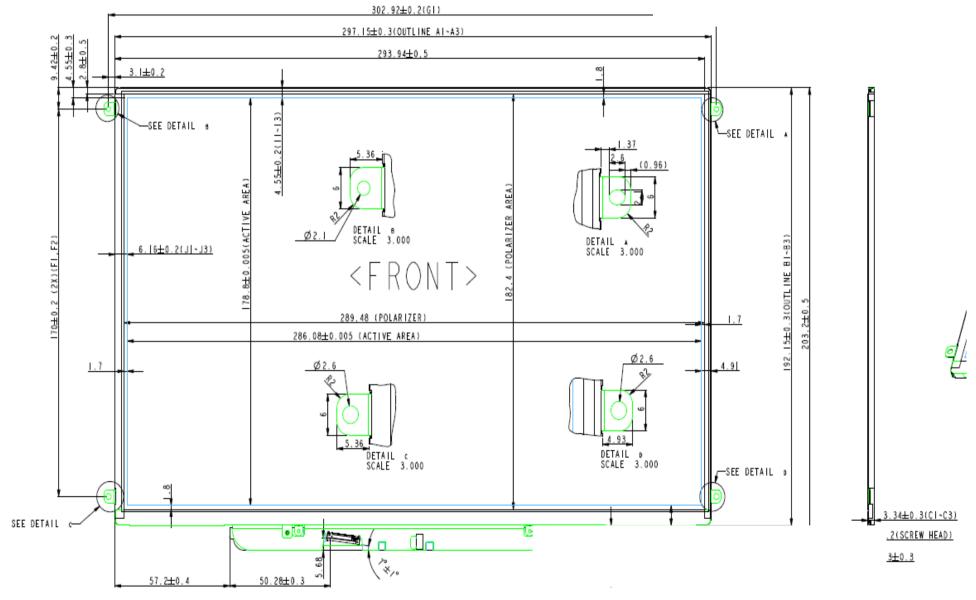
10. Mechanical Characteristics

10.1 LCM Outline Dimension





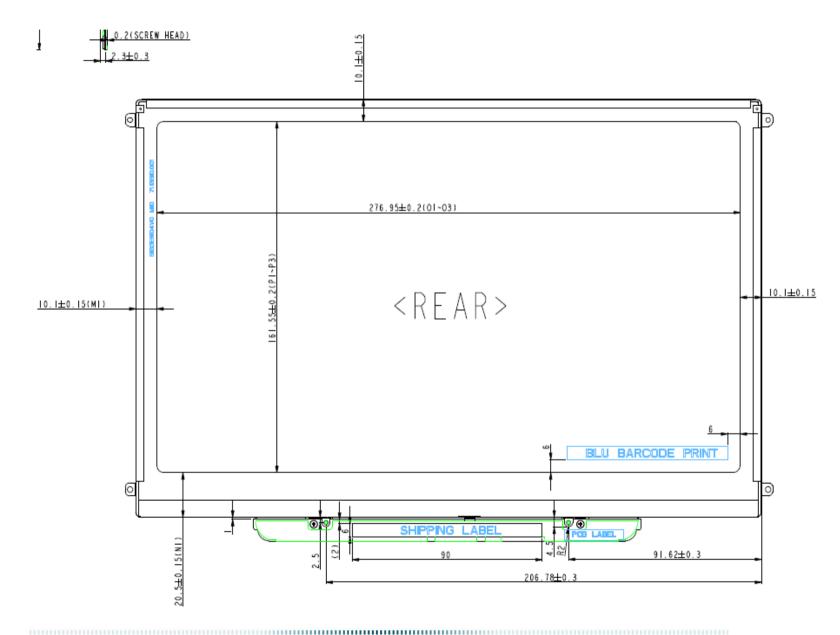
AU OPTRONICS CORPORATION



AUO NBBU spec. Template 1.0 24 of 33



AU OPTRONICS CORPORATION

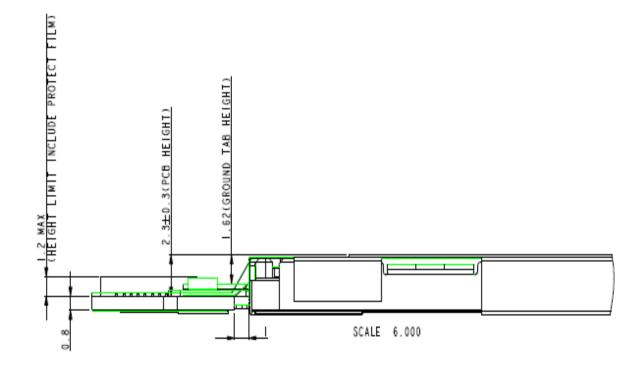


AUO NBBU spec. Template 1.0 25 of 33



AU OPTRONICS CORPORATION





AUO NBBU spec. Template 1.0 26 of 33



- 11. Shipping and Package
- 11.1 Shipping Label Format

11.1 Shipping Label Format

07/11 H/k/0A F/W/0

AU Optranics B133EW04 Vx

MADE IN CHINA (S01)

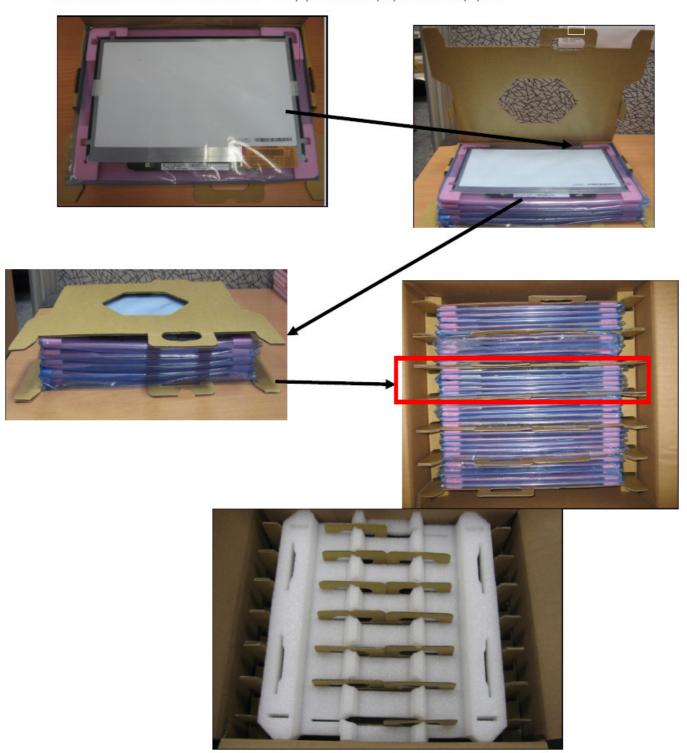
V18wwzzzzxxxA

AUO NBBU spec. Template 1.0

27 of 33

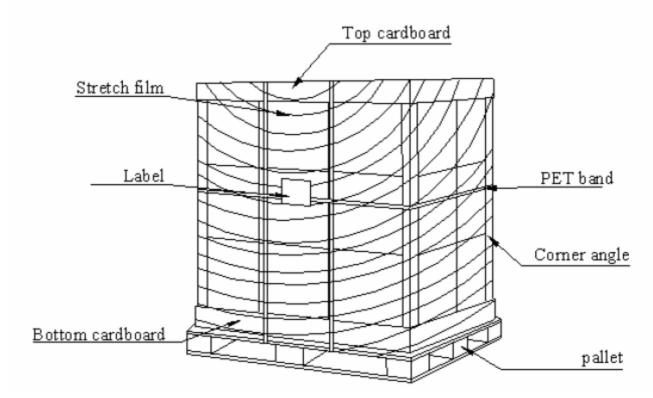


The outside dimension of carton is 435 (L)mm x 377 (W)mm x 335 (H)mm





11.3 Shipping package of palletizing sequence





12. Appendix: EDID description

R133FW04 V0

B13	B133EW04 V0									
Address	FUNCTION	B133EW04	Value	Value	Note					
HEX	Header	HEX	BIN	DEC						
00		00	00000000	0						
01		FF	11111111	255						
02		FF	11111111	255						
03		FF	11111111	255						
04		FF	11111111	255						
05		FF	11111111	255						
06		FF	11111111	255						
07		00	00000000	0						
08	EISA Manuf. Code LSB	06	00000110	6						
09	Compressed ASCII	10	00010000	16						
0A	Product Code	8C	10001100	140						
0B	hex, LSB first	9C	10011100	156						
0C	32-bit ser #	01	0000001	1						
0D		01	00000001	1						
0E		01	0000001	1						
0F		01	00000001	1						
10	Week of manufacture	05	00000101	5						
11	Year of manufacture	12	00010010	18						
12	EDID Structure Ver.	01	0000001	1						
13	EDID revision #	03	00000011	3						
14	Video input definition	80	10000000	128						
15	Max H image size	1D	00011101	29						
16	Max V image size	12	00010010	18						
17	Display Gamma	78	01111000	120						
18	Feature support	0A	00001010	10						
19	Red/green low bits	50	01010000	80						
1A	Blue/white low bits	85	10000101	133						
1B	Red x/ high bits	98	10011000	152						
1C	Red y	58	01011000	88						
1D	Green x	52	01010010	82						
1E	Green y	8E	10001110	142						
1F	Blue x	26	00100110	38						
20	Blue y	25	00100101	37						
21	White x	50	01010000	80						
22	White y	54	01010100	84						
23	Established timing 1	00	00000000	0						
24	Established timing 2	00	00000000	0						
25	Manufacturer's Timing	00	00000000	0						



_		_	-	
26	Standard timing #1	01	00000001	1
27		01	0000001	1
28	Standard timing #2	01	0000001	1
29		01	0000001	1
2A	Standard timing #3	01	0000001	1
2B		01	0000001	1
2C	Standard timing #4	01	0000001	1
2D		01	00000001	1
2E	Standard timing #5	01	00000001	1
2F		01	0000001	1
30	Standard timing #6	01	0000001	1
31		01	0000001	1
32	Standard timing #7	01	0000001	1
33		01	0000001	1
34	Standard timing #8	01	0000001	1
35		01	0000001	1
36	Pixel Clock/10,000 (LSB)	52	01010010	82
37	Pixel Clock/10,000 (MSB)	1C	00011100	28
38	Horiz. Active pixels(Lower 8 bits)	00	00000000	0
39	Horiz.Blanking (Lower 8 bits)	A0	10100000	143
3A	Horiz. Active pixels:Horiz. Blanking (Upper4:4 bits)	50	01010000	80
3B		20	00100000	32
3C		17	00010111	46
3D	Vert. Active pixels:Vert. Blanking (Upper4:4 bits)	30	00110000	48
3E		30	00110000	48
3F		20	00100000	32
40	Vert. Sync. Offset=xx lines, Sync Width=xx lines	36	00110110	54
41	Horz. Ver. Sync/Width (upper 2 bits)	00	00000000	0
42	Hori. Image size (Lower 8 bits)	1E	00011110	30
43	Vert. Image size (Lower 8 bits)	B3	10110011	179
44	Hori. Image size : Vert. Image size (Upper 4 bits)	10	00010000	16
45		00	00000000	0
46		00	00000000	0
47		18	00011000	24
48	Detailed timing/monitor	00	00000000	0
49	descriptor #2	00	00000000	0
4A		00	00000000	0
4B		01	0000001	1
4C	Version	00	00000000	0
4D	Apple edid signature	06	00000110	6
4E	Apple edid signature	10	00010000	16



			JINIOS COLII OI	_	
4F	Link Type (LVDS Link,MSB justified)	20	00100000	32	
50	Pixel and link component format (6-bit panel interface)	00	00000000	0	
51	Panel features (No inverter)	00	00000000	0	
52		00	00000000	0	
53		00	00000000	0	
54		00	00000000	0	
55		00	00000000	0	
56		00	00000000	0	
57		00	00000000	0	
58		0A	00001010	10	
59		20	00100000	32	
5A	Detailed timing/monitor	00	00000000	0	ASCII Data String:B133EW04 V0
5B	descriptor #3	00	00000000	0	
5C		00	00000000	0	
5D		FE	11111110	254	
5E		00	00000000	0	
5F		42	01000010	66	В
60		31	00110001	49	1
61		33	00110011	51	3
62		33	00110011	51	3
63		45	01000101	69	E
64		57	01010111	87	W
65		30	00110000	48	0
66		34	00110100	52	4
67		20	00100000	32	
68		56	01010110	86	V
69		30	00110000	48	1
6A		0A	00001010	10	
6B		20	00100000	32	
6C	Detailed timing/monitor	00	00000000	0	Monitor Name: Color LCD
6D	descriptor #4	00	00000000	0	
6E		00	00000000	0	
6F		FE	11111110	254	
70		00	00000000	0	
71		43	01000011	67	\mathbf{c}
72		6F	01101111	111	0
73		6C	01101100	108	1
74		6F	01101111	111	0
75		72	01110010	114	r
76		20	00100000	32	
77		4C	01001100	76	L
78		43	01000011	67	C



		i	1		
79		44	01000100	68	D
7A		0A	00001010	10	
7B		20	00100000	32	
7C		20	00100000	32	
7D		20	00100000	32	
7E	Extension Flag	00	00000000	0	
7F	Checksum	28	00101110	40	